

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-100V	110mΩ@-10V	-3A
	120mΩ@-4.5V	

Feature

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation

Application

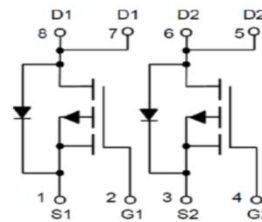
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

Package

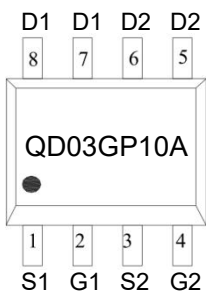


SOP-8

Circuit diagram



Marking



Absolute maximum ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	-3	A
Continuous Drain Current($T_A=100^\circ\text{C}$)	$I_D(100^\circ\text{C})$	-1.9	A
Pulsed Drain Current ¹⁾	I_{DM}	-25	A
Power Dissipation ²⁾	P_D	1.3	W
Thermal Resistance,Junction-to-Ambient ³⁾	$R_{\theta JA}$	90	$^\circ\text{C}/\text{W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Electrical characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-100			V
Zero gate voltage drain current	I_{DSS}	$V_{DS}=-100\text{V}, V_{GS}=0\text{V}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1.0	-1.7	-2.5	V
Drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=-10\text{V}, I_D=-3\text{A}$		85	110	m Ω
		$V_{GS}=-4.5\text{V}, I_D=-2\text{A}$		95	120	
Dynamic characteristics⁴⁾						
Input Capacitance	C_{iss}	$V_{DS}=-50\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$		1050		pF
Output Capacitance	C_{oss}			110		
Reverse Transfer Capacitance	C_{rss}			10		
Total Gate Charge	Q_g	$V_{DS}=-50\text{V}, V_{GS}=-10\text{V}, I_D=-3\text{A}$		20		nC
Gate-Source Charge	Q_{gs}			3.9		
Gate-Drain Charge	Q_{gd}			4.3		
Turn-on delay time	$t_{d(on)}$	$V_{DD}=-50\text{V}, V_{GS}=-10\text{V}, I_D=-3\text{A}, R_{GEN}=2.2\Omega$		10		nS
Turn-on rise time	t_r			30		
Turn-off delay time	$t_{d(off)}$			77		
Turn-off fall time	t_f			81		
Source-Drain Diode characteristics						
Diode Forward Current	I_S				-3	A
Diode Forward voltage	V_{SD}	$V_{GS}=0\text{V}, I_S=-3\text{A}$		-0.9	-1.2	V
Reverse Recovery Time	t_{rr}	$I_F=-3\text{A}, di/dt=100\text{A}/\mu\text{s}$		70		nS
Reverse Recovery Charge	Q_{rr}			140		nC

Notes:

- 1) Repetitive rating; pulse width limited by max. junction temperature.
- 2) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 3) The value of $R_{\theta JA}$ is measured with the device mounted on the minimum recommend pad size, in the still air environment with $T_A=25^\circ\text{C}$. The maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design.
- 4) Guaranteed by design, not subject to production.

Typical Characteristics

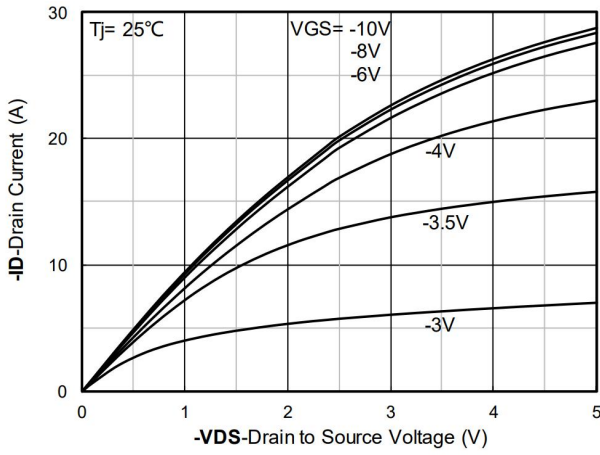


Figure 1. Output Characteristics

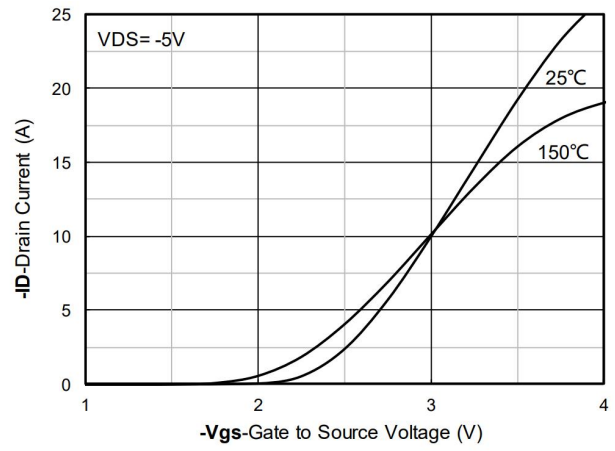


Figure 2. Transfer Characteristics

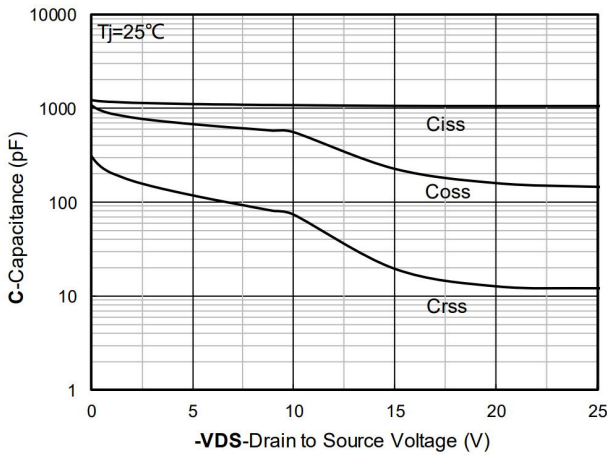


Figure 3. Capacitance Characteristics

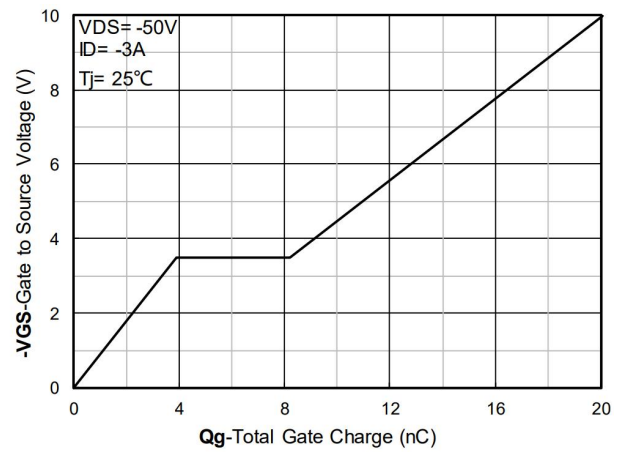


Figure 4. Gate Charge

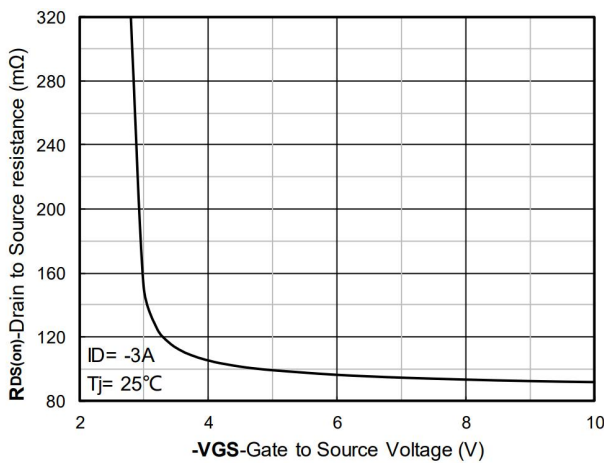


Figure 5. On-Resistance vs Gate to Source Voltage

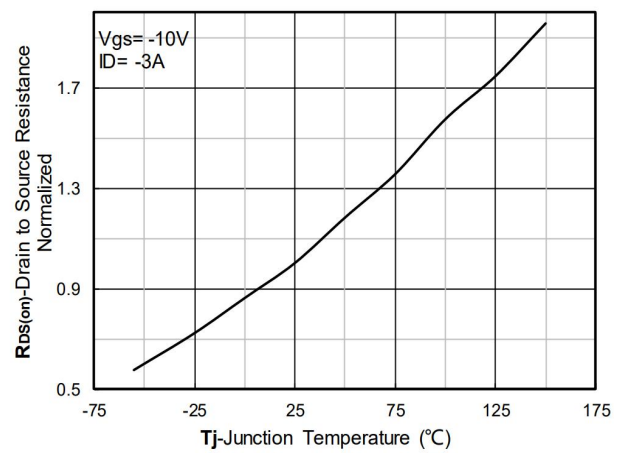


Figure 6. Normalized On-Resistance

Typical Characteristics

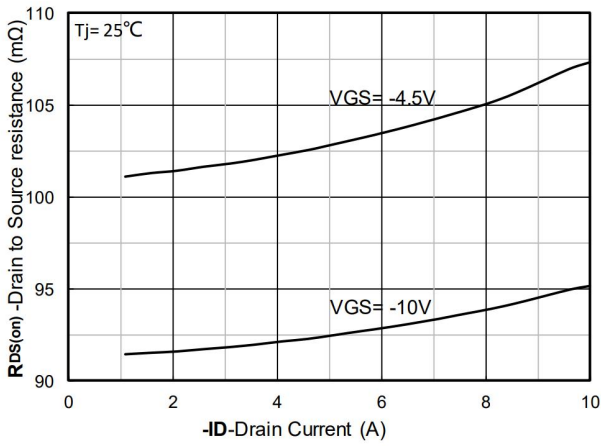


Figure 7. $R_{DS(on)}$ VS Drain Current

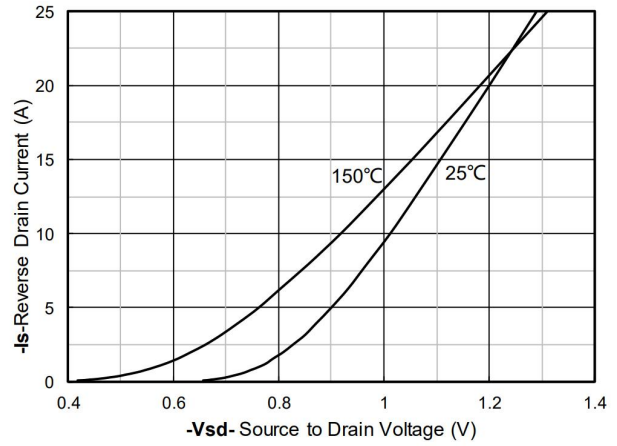


Figure 8. Forward characteristics of reverse diode

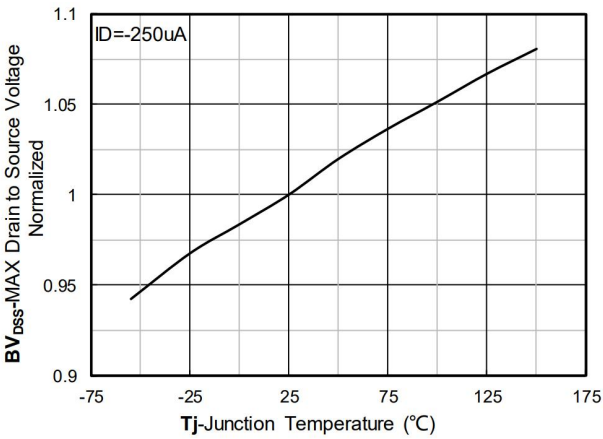


Figure 9. Normalized breakdown voltage

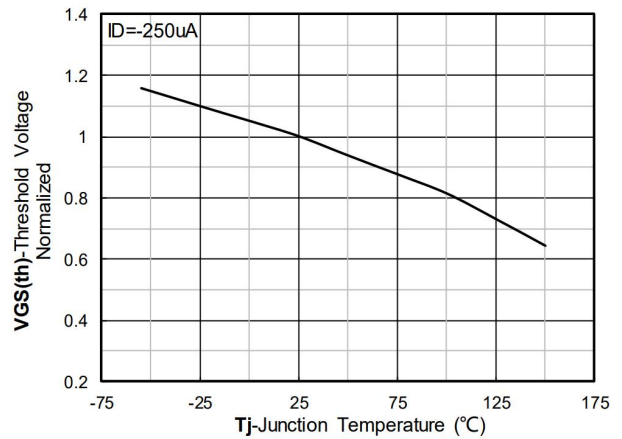


Figure 10. Normalized Threshold voltage

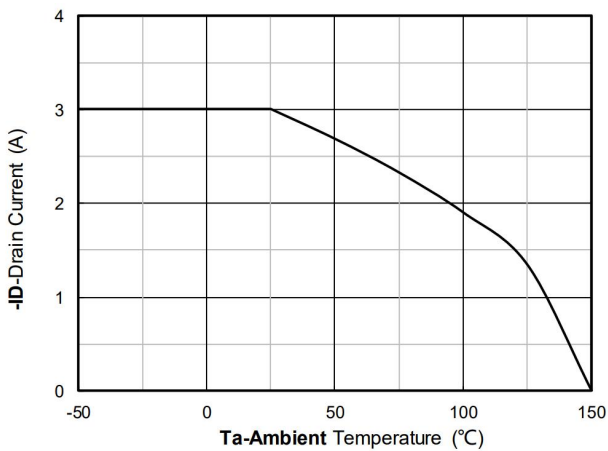


Figure 11. Current dissipation

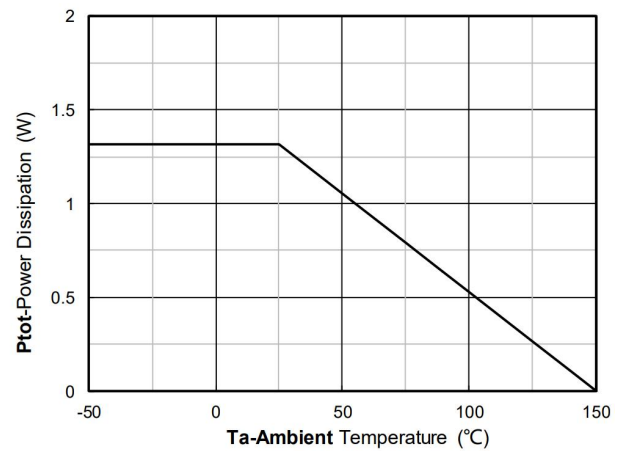


Figure 12. Power dissipation

Typical Characteristics

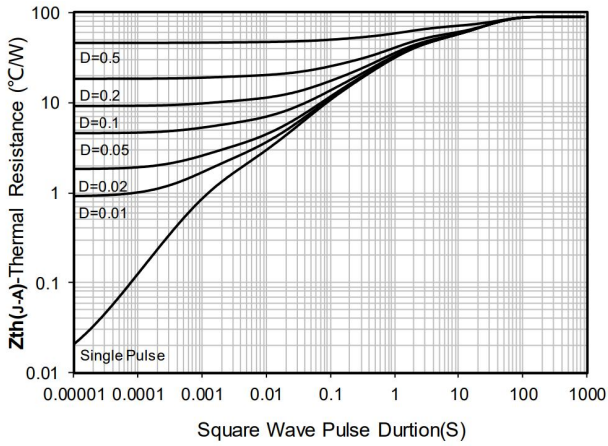


Figure 13. Maximum Transient Thermal Impedance

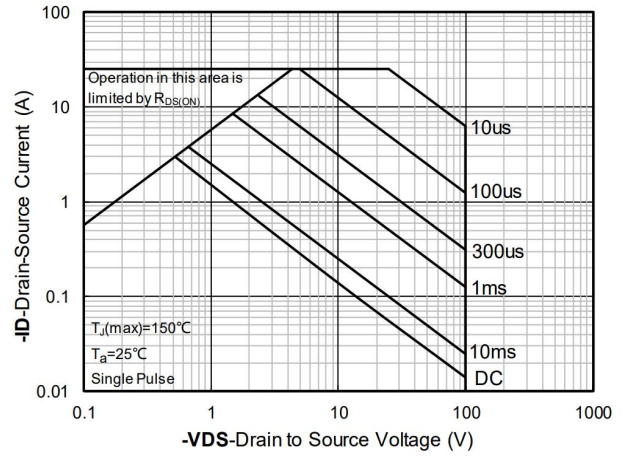
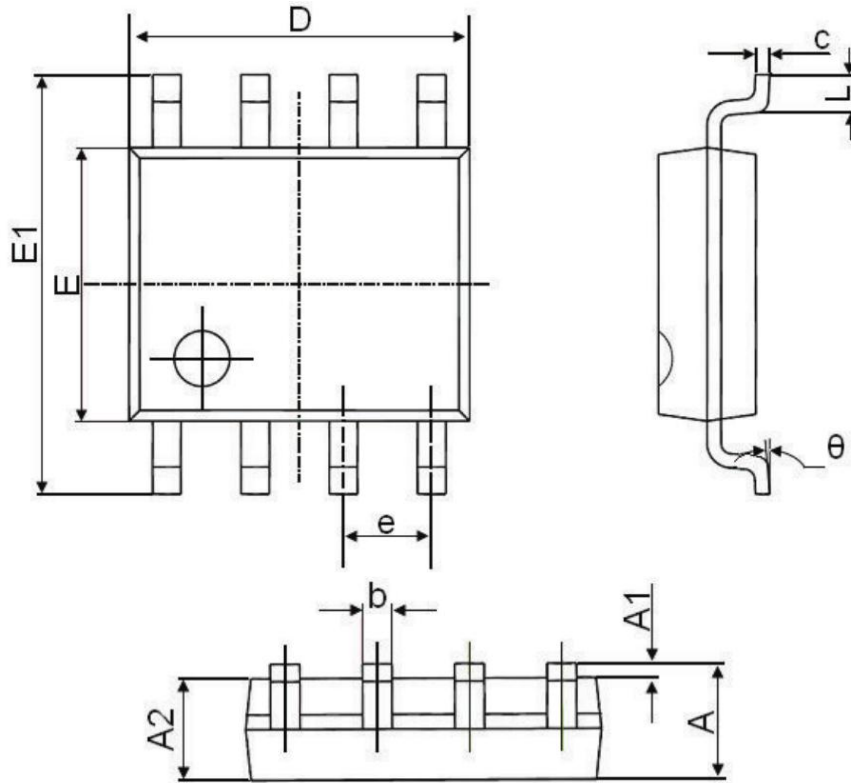


Figure 14. Safe Operation Area

SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.250	1.650	0.049	0.065
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°